

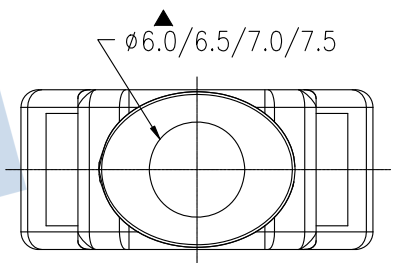
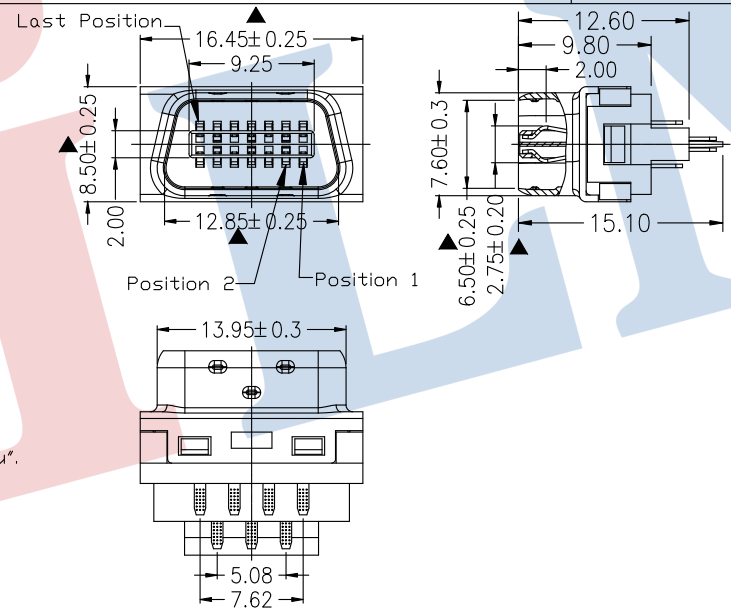
**HSF RoHS**

Specification:

- Contact Resistance: 35 m Ohm Max.
- Insulation Resistance: 200 M Ohm Min. At 500V DC.
- Contact Current Rating: 1 Amp AC/DC
- Voltage Rating: 40V AC.
- Withstanding Voltage: 500V AC For 1 Minute.
- Operating Temperature: -25°C to +85°C
- Packing: Tray
- Control Dimensions Indicated From "▲".

Material and Finish:

- Insulator Material: PBTUL94-V0,Black
- Cover Material: PBTUL94-V0,Black
- Hood Plastic Material: ABS,Black
- Bullon Plastic Material: ABS,Black
- Contact Material: Phosphor Bronze(C5191-EH)T=0.25
- Contact Area Plated: Gold 1~30u" Plated Over Nickel 50u".
- Solder Area Plated: Tin Plated(80u" min Lead Free)
- Up or Down Shell Material: SPCC T=0.50
- Up or Down Shell Plated: Nickel 80u" Plated Over Cu 50u"
- Connector Shell Material: SPCC T=0.50
- Connector Shell Plated: Gold 1~3u" Plated Over Cu 50u"
- Hook Spring Material: Stainless Steel T=0.30



**Ordering Information**  
**6320-M014 S D XX P N A 0 X**

No. of Pins	Connector Type	Contact Plating	Stream Code
14,20P,26P,36P	S=Straight	G1:1U" Gold	
50P		G4:3U" Gold	
		G5:5U" Gold	
		S1:1U" Gold /Tin	
		S2:3U" Gold /Tin	
		S3:5U" Gold /Tin	

				OPERATION		DRAW	YiYuSheng	17.06.22	SCALE	FIT	<b>JILN</b> ® 深圳市锦凌电子有限公司 SHENZHEN JINLING ELECTRONICS CO.,LTD Tel: 86-755-27483253 Fax: 86-755-2997-5588	
				X.X	±0.30							
				X.XX	±0.20	CHECK			SIZE	A4	PART NO.	6320-M014SDXXPNA0X
				X.XXX	±0.10		APPROVE			SHEET		
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	DIM	TOL			PROJ.			TITLE:	HPCN 14P SCSI Solder-type Male
A0	2017.06.22	NEW DRAWING										
1	2	3	4	5	6	7	8	9				